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Number: PMP9454 REV B	Rev: E1	Designed for: Texas Instruments Corp	Date: 9/3/2014
SVN Rev: Not in version control	Assembly Variant: Variant of PMP9454 REV B	Sheet Title: PMP9454 REV B	Sheet: 1 of 1
Drawn By:	File: PMP9454 REV B2.SchDoc	Size: B	
Engineer: Mathew Jacob	Contact: http://www.ti.com/support		



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PCB Number: PMP9454 REVB
PCB Rev: E1

PCB
LOGO
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You should delete the nylon screws/standoffs and/or the bumpers as needed for your design (or substitute other parts from Hardware.IntLib). Bumpers are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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